MOSFET – N-Channel, POWERTRENCH[®], SyncFET™

FDS8672S

General Description

The FDS8672S is designed to replace a single MOSFET and Schottky diode in synchronous DC/DC power supplies. This 30 V MOSFET is designed to maximize power conversion efficiency, providing a low R_{DS(on)} and low gate charge. The FDS8672S includes a patented combination of a MOSFET monolithically integrated with a Schottky diode using ON Semiconductor's monolithic SyncFET technology.

Features

- Max $R_{DS(on)} = 4.8 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 18 \text{ A}$
- Max $R_{DS(on)} = 7.0 \text{ m}\Omega$ at $V_{GS} = 4.5 \text{ V}$, $I_D = 15 \text{ A}$
- Includes SyncFET Schottky Body Diode
- High Performance Trench Technology for Extremely Low R_{DS(on)} and Fast Switching
- High Power and Current Handling Capability
- 100% Rg (Gate Resistance) Tested
- This Device is Pb-Free, Halogen Free/BFR Free and is RoHS Compliant

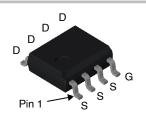
Applications

- Notebook Vcore Low Side Switch
- Synchronous Rectifier for DC/DC Converters
- Point of Load Low Side Switch



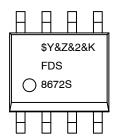
ON Semiconductor®

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SOIC8 CASE 751EB

MARKING DIAGRAM

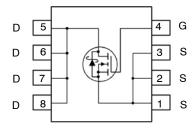


&Y = ON Semiconductor Logo = Assembly Plant Code 87 = Numeric Date Code

= Lot Code

FDS8672S = Specific Device Code

PIN CONFIGURATION



ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet.

MOSFET MAXIMUM RATINGS ($T_A = 25^{\circ}C$ Unless Otherwise Noted)

Symbol	Parameter	Ratings	Unit	
V _{DS}	Drain to Source Voltage	30	V	
V _{GS}	Gate to Source Voltage	±20	V	
I _D	Drain Current -Continuous	18	Α	
	Drain Current -Pulsed (Note 4)	80		
E _{AS}	Single Pulse Avalanche Energy (Note 3)	216	mJ	
P _D	Power Dissipation T _A = 25°C (Note 1a)	2.5	W	
. 0	Power Dissipation T _A = 25°C (Note 1b)	1.0	.,	
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 to +150	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Symbol	Parameter	Ratings	Unit
$R_{ heta JC}$	Thermal Resistance, Junction to Case (Note 1)	25	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	

ELECTRICAL CHARACTERISTICS (T_J = 25°C Unless Otherwise Noted)

	D			T		1114
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS					
BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	30			V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temperature Coefficient	I _D = 10 mA, referenced to 25°C		33		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V			500	μΑ
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20 V, V _{DS} = 0 V			±100	nA
ON CHARA	CTERISTICS		•	-	•	•
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$	1.0	2.1	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}/$	Gate to Source Threshold Voltage Temperature Coefficient	I _D = 10 mA, referenced to 25°C		-5		mV/°C
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 18 A		3.8	4.8	mΩ
		V _{GS} = 4.5 V, I _D = 15 A		5.3	7.0	
		V _{GS} = 10 V, I _D = 18 A, T _J = 125°C		5.3	7.8	
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 18 A		78		S
DYNAMIC (CHARACTERISTICS					
C _{iss}	Input Capacitance	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		2005	2670	pF
C _{oss}	Output Capacitance			985	1310	pF
C _{rss}	Reverse Transfer Capacitance			135	205	pF
R _g	Gate Resistance	f = 1 MHz		0.6	2.0	Ω
SWITCHING	G CHARACTERISTICS		•	-		-
t _{d(on)}	Turn-On Delay Time	V _{DD} = 15 V, I _D = 18 A, V _{GS} = 10 V,		12	22	ns
t _r	Rise Time	$R_{GEN} = 6 \Omega$		4	10	ns
t _{d(off)}	Turn-Off Delay Time			26	42	ns
t _f	Fall Time			3	10	ns

ELECTRICAL CHARACTERISTICS (T. = 25°C Unless Otherwise Noted) (continued)

Symbol	Parameter	Test Conditions		Min	Тур	Max	Unit	
SWITCHING CHARACTERISTICS								
Qg	Total Gate Charge	V _{GS} = 0 V to 10 V	V _{DD} = 15 V, I _D = 18 A		29	41	nC	
Qg	Total Gate Charge	V _{GS} = 0 V to 5 V]		15	21	nC	
Q _{gs}	Gate to Source Charge	1			5.5		nC	
Q_{gd}	Gate to Drain "Miller" Charge	1			3.7		nC	
DRAIN-SO	URCE DIODE CHARACTERISTICS							
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _S = 18 A V _{GS} = 0 V, I _S = 1.8 A			0.8 0.4	1.2 0.7	V	
t _{rr}	Reverse Recovery Time	I _F = 18 A, di/dt = 300 A/μs			27	43	ns	
Qrr	Reverse Recovery Charge				31	50	nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. $R_{\theta JA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 \times 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a. 50°C/W when mounted on a 1in² pad of 2 oz copper.



b. 125°C/W when mounted on a minimum pad.

- 2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%.
- Starting T_J = 25°C, L = 3 mH, I_{AS} = 12 A, V_{DD} = 30 V, V_{GS} = 10 V.
 Pulse current was measured at 250 μs pulse, refer to Figure x11 Forward Safe Operation Area for detail.

PACKAGE MARKING AND ORDERING INFORMATION

Device Marking	Device	Package	Reel Size	Tape Width	Shipping [†]
FDS8672S	FDS8672S	SOIC8	13″	12 mm	2,500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

TYPICAL CHARACTERISTICS

(T_J = 25°C Unless Otherwise Noted)

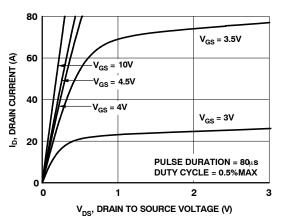


Figure 1. On-Region Characteristics

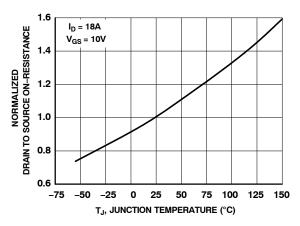


Figure 3. Normalized On Resistance vs Junction Temperature

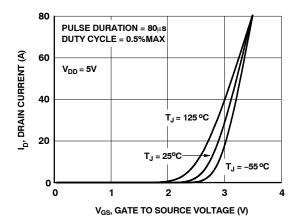


Figure 5. Transfer Characteristics

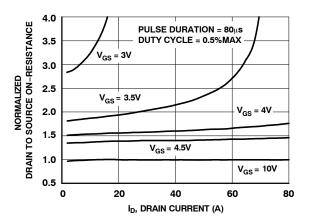


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

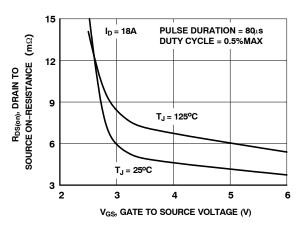


Figure 4. On-Resistance vs Gate to Source Voltage

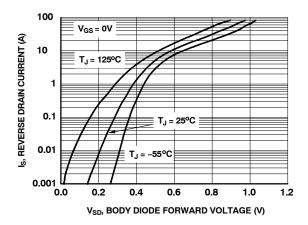


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

TYPICAL CHARACTERISTICS (Continued)

(T_J = 25°C Unless Otherwise Noted)

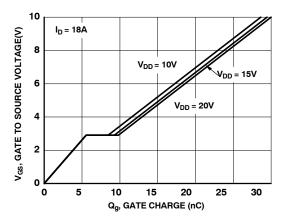


Figure 7. Gate Charge Characteristics

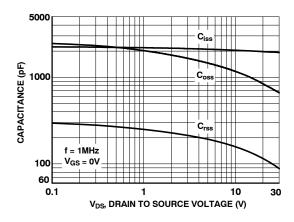


Figure 8. Capacitance vs. Drain to Source Voltage

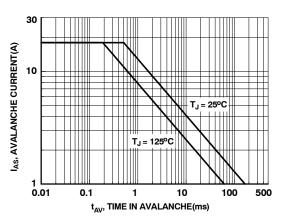


Figure 9. Unclamped Inductive Switching Capability

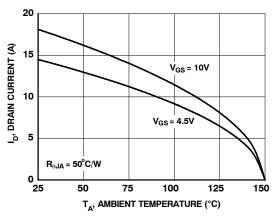


Figure 10. Maximum Continuous Drain Current vs.

Ambient Temperature

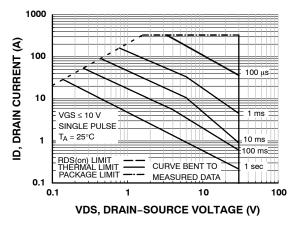


Figure 11. Forward Bias Safe Operating Area

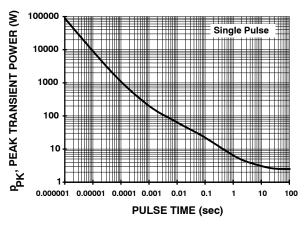


Figure 12. Single Pulse Maximum Power Dissipation

TYPICAL CHARACTERISTICS (Continued)

(T_J = 25°C Unless Otherwise Noted)

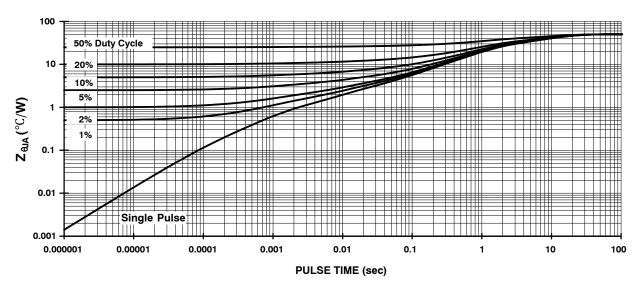
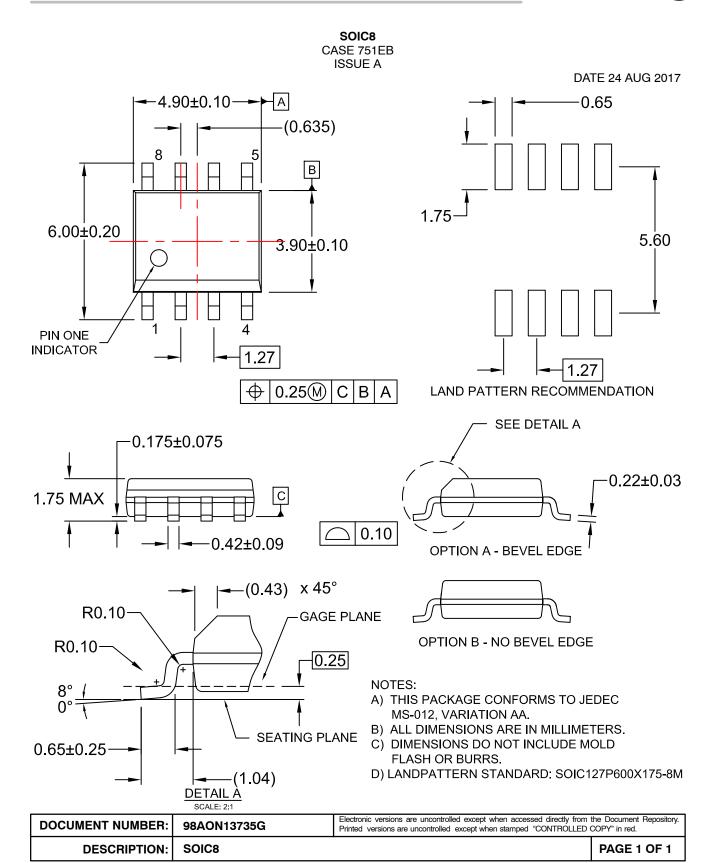


Figure 13. Junction-to-Ambient Transient Thermal Response Curve

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